

S/N 09/259849

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner: Ginette Peralta

Serial No.: 09/259849

Group Art Unit: 2814

Filed: March 1, 1999

Docket: 303.557US1

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS



COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RECEIVED
NOV 24 2003
TECHNOLOGY CENTER 2800

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
09/032197 6211073	February 27, 1998	303.459US1	METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS
09/817447	March 26, 2001	303.459US2	METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS
09/128859 6284656	August 4, 1998	303.473US1	COPPER METALLURGY IN INTEGRATED CIRCUITS
09/946055 6614099	September 4, 2001	303.473US2	COPPER METALLURGY IN INTEGRATED CIRCUITS
09/145012 6288442	September 1, 1998	303.505US1	INTEGRATED-CIRCUIT WITH OXIDATION-RESISTANT POLYMERIC LAYER
09/256123 6211049	February 24, 1999	303.505US2	FORMING SUBMICRON INTEGRATED-CIRCUIT WIRING FROM GOLD, SILVER, COPPER AND OTHER METALS

COMMUNICATION CONCERNING CO-PENDING APPLICATIONS

Serial Number: 09/259849

Filing Date: March 1, 1999

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS

Page 2

Dkt: 303.557US1

09/256124 6208016	February 24, 1999	303.505US3	FORMING SUBMICRON INTEGRATED-CIRCUIT WIRING FROM GOLD, SILVER, COPPER AND OTHER METALS
09/789091	February 20, 2001	303.505US4	INTEGRATED-CIRCUIT WITH OXIDATION-RESISTANT POLYMERIC LAYER

Respectfully submitted,

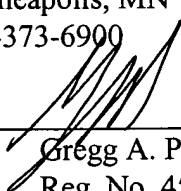
PAUL A. FARRAR

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
P.O. Box 2938
Minneapolis, MN 55402
612-373-6900

Date 11-14-03

By

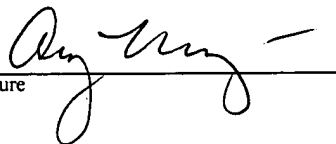

Gregg A. Peacock
Reg. No. 45,001

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 14th day of November, 2003.

Name

Amy Moriarty

Signature



41
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

28/4

Applicant: Paul A. Farrar

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS

Docket No.: 303.557US1

Filed: March 1, 1999

Examiner: Ginette Peralta

Customer No.: 21186



Serial No.: 09/259849

Due Date: November 14, 2003

Group Art Unit: 2814

Confirmation No.: 5766

RECEIVED
NOV 24 2003
TECHNOLOGY CENTER 2800

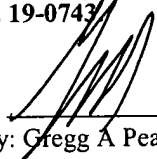
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Amendment and Response (20 Pages).
- ☒ Communication Concerning Co-Pending Applications (2 pgs.).

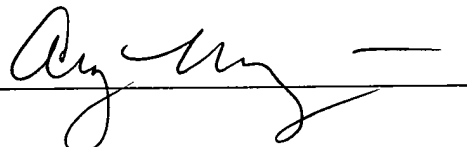
Please consider this a **PETITION FOR EXTENSION OF TIME** for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
Customer Number 21186

By: 
Atty: Gregg A. Peacock
Reg. No. 45,001

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O.Box 1450, Alexandria, VA 22313-1450, on this 14th day of November, 2003.

Amy Moriarty
Name


Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
(GENERAL)

Customer Number 21186